

Title (en)
POSITIVE RESIST COMPOSITION

Title (de)
POSITIVE RESISTZUSAMMENSETZUNG

Title (fr)
COMPOSITION DE RÉSINE PHOTOSENSIBLE POSITIVE

Publication
EP 2255250 B1 20190313 (EN)

Application
EP 09724389 A 20090326

Priority

- JP 2009056837 W 20090326
- JP 2008088776 A 20080328
- JP 2009049662 A 20090303
- JP 2009071006 A 20090323

Abstract (en)
[origin: WO2009119894A1] A positive resist composition and a pattern forming method using the resist composition are provided, the resist composition including: (A) a resin containing a repeating structural unit represented by formula (I) as defined in the specification and being capable of decomposing by an action of an acid to increase the solubility in an alkali developer; (B) an acid generator; and (C) a mixed solvent containing at least one solvent selected from the group consisting of the following Group (a) and at least one solvent selected from the group consisting of the following Groups (b) to (d): Group (a): an alkylene glycol monoalkyl ether, Group (b): an alkylene glycol monoalkyl ether carboxylate, Group (c): a linear ketone, a branched chain ketone, a cyclic ketone, a lactone and an alkylene carbonate, and Group (d): a lactic acid ester, an acetic acid ester and an alkoxypropionic acid ester.

IPC 8 full level
G03F 7/004 (2006.01); **G03F 7/039** (2006.01); **G03F 7/20** (2006.01)

CPC (source: EP KR US)
G03F 7/0007 (2013.01 - KR US); **G03F 7/004** (2013.01 - KR); **G03F 7/0045** (2013.01 - KR); **G03F 7/0046** (2013.01 - KR); **G03F 7/0048** (2013.01 - EP US); **G03F 7/0392** (2013.01 - KR); **G03F 7/0397** (2013.01 - EP KR US); **G03F 7/0758** (2013.01 - KR); **G03F 7/2041** (2013.01 - EP KR US); **H01L 21/027** (2013.01 - KR); **H01L 21/0271** (2013.01 - KR); **G03F 7/0046** (2013.01 - EP US); **G03F 7/0758** (2013.01 - EP US); **Y10S 430/111** (2013.01 - EP US)

Citation (examination)

- US 2007218401 A1 20070920 - ANDO NOBUO [JP], et al
- JP 2007249192 A 20070927 - SUMITOMO CHEMICAL CO

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DOCDB simple family (publication)
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